

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re U.S. Patent Application of)
YASUI et al.)
Application Number: To Be Assigned)
Filed: Concurrently Herewith)
For: PLANARIZING METHOD OF SEMICONDUCTOR)
WAFER AND APPARATUS THEREOF)



Honorable Assistant Commissioner
for Patents
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Sir:

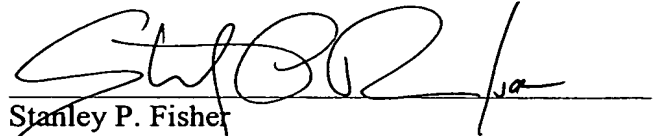
Pursuant to 37 C.F.R. §§ 1.51(b) and 1.56, this Information Disclosure Statement is submitted in the above-identified patent application. A listing of documents to be published on the face of any patent granted from this application is submitted herewith on Form PTO-1449. Any other documents or information submitted for consideration by the Examiner are listed in this paper. A copy of each U.S. and foreign patent, or each publication or portion thereof listed or herein identified, is submitted herewith.

This Information Disclosure Statement is submitted with the initial application. Accordingly, no fee is due or payable at this time.

The Examiner is requested to acknowledge consideration of the information provided in this paper in accordance with prescribed procedures.

Please charge any additional fees or credit any overpayments in connection with this paper to Deposit Account No. 08-1480.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Stanley P. Fisher", written over a horizontal line.

Stanley P. Fisher

Registration Number 24,344

REED SMITH HAZEL & THOMAS LLP

3110 Fairview Park Drive

Suite 1400

Falls Church, Virginia 22042

(703) 641-4200

July 24, 2001

JUAN CARLOS A. MARQUEZ

Registration No. 34,072